



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification# 20190523001
Datasheet for TXB0304
Information Only**

Date: July 03, 2019
To: PREMIER FARNELL PCN

Dear Customer:

This is an information-only announcement of a change to the datasheet for a device that is currently offered by Texas Instruments.

The changes discussed within this notification are for your information only.

Any negotiated alternative change requirements will be provided via the customer's defined process. Customers with previously negotiated, special requirements will be handled separately. Any inquiries should be directed to your local Field Sales Representative.

For questions regarding this notice, contact your local Field Sales Representative or the PCN team (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services


Information Only Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
TXB0304RSVR	null
TXB0304RUTR	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20190523001	PCN Date:	July 3, 2019						
Title:	Datasheet for TXB0304								
Customer Contact:	PCN Manager	Dept:	Quality Services						
Change Type:									
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site							
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material							
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process							
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site							
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials							
		<input type="checkbox"/> Wafer Fab Process							
Notification Details									
Description of Change:									
<p>Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below. The following change history provides further details.</p>									
		TXB0304 <small>SCES831G – SEPTEMBER 2011 – REVISED MAY 2019</small>							
Changes from Revision F (May 2016) to Revision G			Page						
<ul style="list-style-type: none"> Changed text in <i>Power Supply Recommendations</i> section. 			13						
<p>The datasheet number will be changing.</p> <table border="1"> <tr> <td>Device Family</td> <td>Change From:</td> <td>Change To:</td> </tr> <tr> <td>TXB0304</td> <td>SCES831F</td> <td>SCES831G</td> </tr> </table>				Device Family	Change From:	Change To:	TXB0304	SCES831F	SCES831G
Device Family	Change From:	Change To:							
TXB0304	SCES831F	SCES831G							
<p>These changes may be reviewed at the datasheet links provided. http://www.ti.com/product/TXB0304</p>									
Reason for Change:									
To accurately reflect device characteristics.									
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):									
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.									
Changes to product identification resulting from this PCN:									
None.									
Product Affected:									
TXB0304RSVR	TXB0304RUTR	TXBN0304RSVR	TXBN0304RUTR						

For questions regarding this notice, e-mails can be sent to the contacts shown below or your local Field Sales Representative.

Location	E-Mail
USA	PCNAmericasContact@list.ti.com
Europe	PCNEuropeContact@list.ti.com
Asia Pacific	PCNAsiaContact@list.ti.com
WW PCN Team	PCN_ww_admin_team@list.ti.com